PME295 Series Metallized Impregnated Paper, Class Y1, 440 VAC/480 VAC



Overview

The PME295 Series is constructed of multilayer metallized paper encapsulated and impregnated in self-extinguishing material meeting the requirements of UL 94 V–0.

Applications

Typical applications include safety capacitors for bridging of double or reinforced insulation applications requiring voltage test up to 4,000 VAC at 60 seconds. PME295 Series capacitors can be left in place during this test.

Benefits

· Approvals: ENEC, UL, cUL

Rated voltage: 440 VAC/480 VAC 50/60 Hz

• Capacitance range: 470 – 4700 pF

· Lead spacing: 15.0 mm

• Capacitance tolerance: ±20%

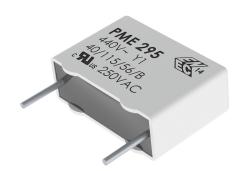
Climatic category: 40/115/56/B, IEC 60068–1

Tape and reel packaging in accordance with IEC 60286–2

· RoHS Compliant and lead-free terminations

• Operating temperature range of -40°C to +115°C

• 100% screening factory test at 4,000 VAC, 50 Hz, 2 seconds



Legacy Part Number System

PME295	R	В	3470	M	R30
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
Y1, Metallized Paper	R = 440	B = 15.0	The last three digits represent significant figures. The first digit specifies the total number of digits.	M = ±20%	See Ordering Options Table

New KEMET Part Number System

Р	295	В	E	471	M	440	Α
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
P = Paper	Y1, Metallized Paper	B = 15.0	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20%	440 = 440	See Ordering Options Table



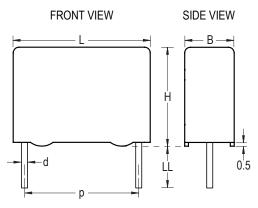
Benefits cont'd

- Highest possible safety regarding active and passive flammability
- Excellent self-healing properties ensure long life even when subjected to frequent over voltages
- · Good resistance to ionization due to impregnated dielectric
- · High dV/dt capability
- Impregnated paper provides excellent stability and reliability properties, particularly in applications with continuous operation

Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Bag) – Short Leads	6 +0/-1	С	R06
15	Bulk (Bag) – Max Length Leads	30 +5/-0	А	R30
15	Tape & Reel (Standard Reel)	H ₀ = 18.5 +/-0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H ₀ = 18.5 +/-0.5	Р	R19T1
Native 15	Ammo Pack	H ₀ = 16.5 +/-0.5	LAF3	R30XA
formed to 7.5	Tape & Reel (Standard Reel)	H ₀ = 16.5 +/-0.5	XLTF1	R25X2

Dimensions - Millimeters



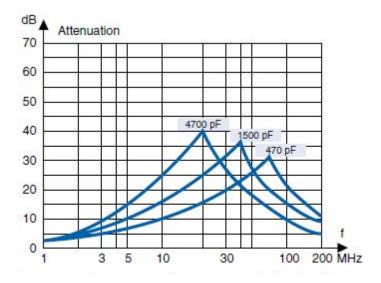
	рВ		3	Н		L		d			
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance		
15	+/-0.4	5.5	Maximum	12.5	Maximum	18	Maximum	0.8	+/-0.05		
15	+/-0.4	6.5	Maximum	12.5	Maximum	18	Maximum	0.8	+/-0.05		
15	+/-0.4	7.5	Maximum	14.5	Maximum	18	Maximum	0.8	+/-0.05		
15	+/-0.4	.4 8.5 Maximum		16 Maximum		18	Maximum	0.8	+/-0.05		
	Note: See Ordering Options Table for lead length (LL) options.										



Performance Characteristics

Rated Voltage	440 VAC 50/60 Hz (ENEC)			
Kaleu Vollage	480 VAC 50/60 Hz (UL, cUL)			
Capacitance Range	0.00047 – 0.0047 μF			
Capacitance Tolerance	±20%			
Temperature Range	-40°C to +115°C			
Climatic Category	40/115/56/B			
Approvals	ENEC, UL, cUL			
Discipation Factor	Maximum Values at +23°C			
Dissipation Factor	1 kHz 1.3%			
Test Voltage Between Terminals	The 100% screening factory test is 2 seconds. The voltage level is sele in applicable equipment standards. checked after the test.	cted to meet the requirements		
	Measured at 500 VDC a	fter 60 seconds, +23°C		
Insulation Resistance	Minimum Value B	etween Terminals		
	≥ 12,00	00 ΜΩ		
In DC Applications	Recommended voltage ≤ 1,500 VDC			
Resonance Frequency	Tabulated self-resonance frequenci	es f ₀ refer to 5 mm lead length		

Suppression vs. Frequency, Typical Values





Environmental Test Data

Test	IEC Publication	Procedure		
Endurance	IEC 60384-14	1.7 x V _R Vac 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature.		
Vibration	IEC 60068-2-6	3 directions at 2 hours each		
VIDIATION	Test Fc	10 – 500 Hz at 0.75 mm or 98m/s2		
Bump	IEC 60068–2–29 Test Eb	4,000 bumps at 390 m/s ²		
Change of Temperature	IEC 60068-2-14 test Na	Upper and lower rated temperature 5 cycles		
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test		
Humidity	IEC 60068-2-3 Test Ca	+40°C and 93% RH, 56 days		

Approvals

Certification Body	Mark	Specification	File Number
Intertek Semko AB		EN/IEC 60384-14 (440 VAC)	SE/0140-13C
		UL 60384-14	E73869
UL	C TUS	CAN/CSA-E60384-14:09	⊏/3009

Environmental Compliance

All KEMET EMI capacitors are RoHS Compliant.



Table 1 – Ratings & Part Number Reference

Capacitance	Maximum	Dimensio	ns in mm	Lead	f	dV/dt	New KEMET Part	Legacy Part
Value (µF)	В	Н	L	Spacing (p)	(MHz)	(V/µs)	Number	Number
0.00047	5.5	12.5	18	15	64	2000	P295BE471M440(1)	PME295RB3470M(1)
0.00056	5.5	12.5	18	15	59	2000	P295BE561M440(1)	PME295RB3560M(1)
0.00068	5.5	12.5	18	15	54	2000	P295BE681M440(1)	PME295RB3680M(1)
0.00082	5.5	12.5	18	15	49	2000	P295BE821M440(1)	PME295RB3820M(1)
0.001	5.5	12.5	18	15	46	2000	P295BE102M440(1)	PME295RB4100M(1)
0.0012	6.5	12.5	18	15	43	2000	P295BJ122M440(1)	PME295RB4120M(1)
0.0015	6.5	12.5	18	15	40	2000	P295BJ152M440(1)	PME295RB4150M(1)
0.0018	6.5	12.5	18	15	37	2000	P295BJ182M440(1)	PME295RB4180M(1)
0.0022	6.5	12.5	18	15	33	2000	P295BJ222M440(1)	PME295RB4220M(1)
0.0025	7.5	14.5	18	15	31	2000	P295BL252M440(1)	PME295RB4250M(1)
0.0027	7.5	14.5	18	15	30	2000	P295BL272M440(1)	PME295RB4270M(1)
0.0033	7.5	14.5	18	15	27	2000	P295BL332M440(1)	PME295RB4330M(1)
0.0039	8.5	16	18	15	24	2000	P295BQ392M440(1)	PME295RB4390M(1)
0.0047	8.5	16	18	15	22	2000	P295BQ472M440(1)	PME295RB4470M(1)
Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	f _o (MHz)	dV/dt (V/μs)	New KEMET Part Number	Legacy Part Number

⁽¹⁾ Insert ordering code for lead type and packaging. See Ordering Options Table for available options.



Soldering Process

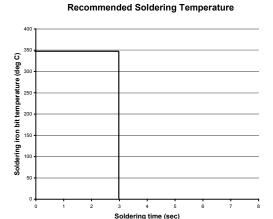
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

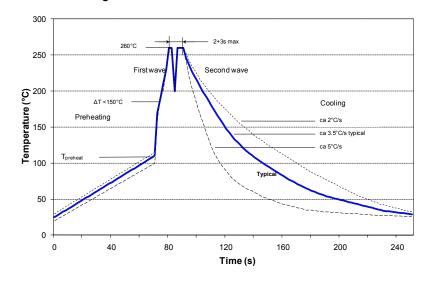
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont'd

Wave Soldering Recommendations cont'd

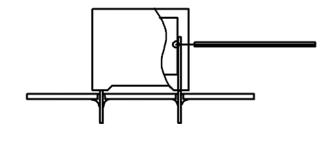
1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu	m Preheat Peak Solder Temperatu		
Film Material	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene sulphide	160°C



Temperature monitored inside the capacitor.

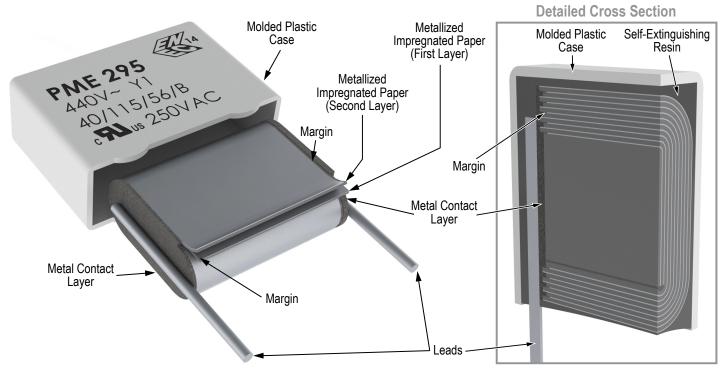
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

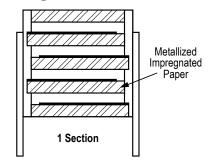
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however**, **instead of two baths**, **there is only one bath with a time from 3 to 10 seconds**. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



Construction

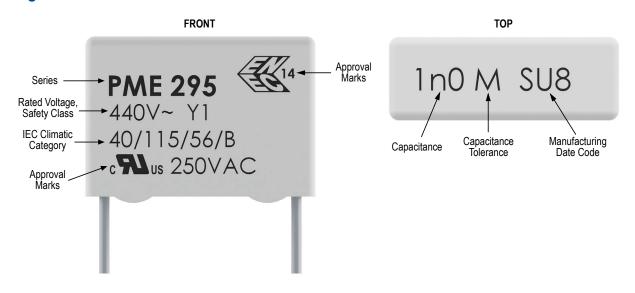


Winding Scheme





Marking



Packaging Quantities

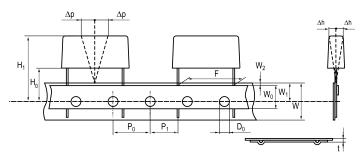
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel Ø 360 mm	Large Reel Ø 500 mm	Standard Reel Formed	Ammo Formed
	5.5	10.5	18	1000	800	600	1200	550	570
	5.5	12.5	18	1000	800	600	1200	550	570
	7.5	14.5	18	800	400	400	800	350	378
	6.5	12.5	18	1000	600	500	1000	450	480
15	8.5	16	18	600	400	400	800	350	324
15	8	15	18	600	400	400	800	350	351
	9.5	17.5	18	500	300	350	700	250	297
	6	12	18	1000	800	500	1000	450	520
	11	19	18	450	250	300	600	250	252
	13	12.5	18	400	300	250	500	200	216



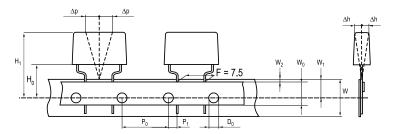
Lead Taping & Packaging (IEC 60286-2)

Lead Spacing 10.2 – 15.2 mm

Lead Spacing 20.3 - 22.5 mm



Formed Leads from 10.2 to 7.5 mm



Taping Specification

	Dimensions in mm											
Lead spacing	+6/-0.1	F	Formed 7.5	10.2	15.2	20.3	22.5	F				
Carrier tape width	+/-0.5	W	18	18	18	18	18	18+1/-0.5				
Hold-down tape width	+/-0.3	W_{0}	9	12	12	12	12					
Position of sprocket hole	+/-0.5	W ₁	9	9	9	9	9	g+0.75/-0.5				
Distance between tapes	Maximum	W ₂	3	3	3	3	3	3				
Sprocket hole diameter	+/-0.2	D ₀	4	4	4	4	4	4				
Feed hole lead spacing	+/-0.3	P ₀ ⁽¹⁾	12.7(4)	12.7	12.7	12.7	12.7	12.7				
Distance lead – feed hole	+/-0.7	P ₁	3.75	7.6	5.1	8.9	5.3	P ¹				
Deviation tape – plane	Maximum	Δp	1.3	1.3	1.3	1.3	1.3	1.3				
Lateral deviation	Maximum	Δh	2	2	2	2	2	2				
Total thickness	+/-0.2	t	0.7	0.7	0.7	0.7	0.9 ^{MAX}	0.9 ^{MAX}				
Sprocket hole/cap body	Nominal	H ₀ ⁽²⁾	18+2/-0	18+2/-0	18+2/-0	18+2/-0	18.5+/-0.5	18+2/-0				
Sprocket hole/top of cap body	Maximum	H ₁ ⁽³⁾	35	35	35	35	58	58 ^{MAX}				

⁽¹⁾ Maximum cumulative feed hole error, 1 mm per 20 parts.

^{(2) 16.5} mm available on request.

⁽³⁾ Depending on case size.

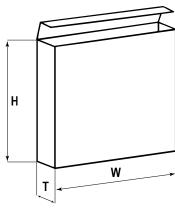
^{(4) 15} mm available on request.



Lead Taping & Packaging (IEC 60286-2) cont'd

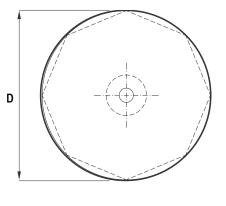
Ammo Specifications

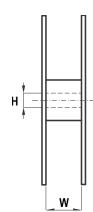
Series	Dimensions (mm)		
	Н	W	Т
R4x, R4x+R, R7x, RSB			
F5A, F5B, F5D	360	340	59
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx	330	330	50



Reel Specifications

Series	Dimensions (mm)		
	D	Н	W
R4x, R4x+R, R7x, RSB	055	30 25	55 (Max)
F5A, F5B, F5D	355 500		
F6xx, F8xx	300	25	
PHExxx, PMExxx, PMRxxx	360 500	30	46 (Max)





Manufacturing Date Code (IEC-60062)

Y = Year, Z = Month					
Year	Code	Month	Code		
2000	M	January	1		
2001	N	February	2		
2002	Р	March	3		
2003	R	April	4		
2004	S	May	5		
2005	T	June	6		
2006	U	July	7		
2007	V	August	8		
2008	W	September	9		
2009	X	October	0		
2010	Α	November	N		
2011	В	December	D		
2012	С				
2013	D				
2014	E				
2015	F				
2016	Н				
2017	J				
2018	K				
2019	L				
2020	M				



KEMET Corporation World Headquarters

2835 KEMET Way Simpsonville, SC 29681

Mailing Address: P.O. Box 5928 Greenville, SC 29606

www.kemet.com Tel: 864-963-6300 Fax: 864-963-6521

Corporate Offices Fort Lauderdale, FL Tel: 954-766-2800

North America

Southeast

Lake Mary, FL Tel: 407-855-8886

Northeast

Wilmington, MA Tel: 978-658-1663

Central

Novi, MI

Tel: 248-306-9353

West

Milpitas, CA Tel: 408-433-9950

Mexico

Guadalajara, Jalisco Tel: 52-33-3123-2141

Europe

Southern Europe Sasso Marconi, Italy Tel: 39-051-939111

Skopje, Macedonia Tel: 389-2-55-14-623

Central Europe Landsberg, Germany Tel: 49-8191-3350800

Kamen, Germany Tel: 49-2307-438110

Northern Europe Harlow, United Kingdom Tel: 44-1279-460122

Espoo, Finland Tel: 358-9-5406-5000

Asia

Northeast Asia Hong Kong Tel: 852-2305-1168

Shenzhen, China Tel: 86-755-2518-1306

Beijing, China Tel: 86-10-5877-1075

Shanghai, China Tel: 86-21-6447-0707

Seoul, South Korea Tel: 82-2-6294-0550

Taipei, Taiwan Tel: 886-2-27528585

Southeast Asia

Singapore Tel: 65-6701-8033

Penang, Malaysia Tel: 60-4-6430200

Bangalore, India Tel: 91-806-53-76817

Note: KEMET reserves the right to modify minor details of internal and external construction at any time in the interest of product improvement. KEMET does not assume any responsibility for infringement that might result from the use of KEMET Capacitors in potential circuit designs. KEMET is a registered trademark of KEMET Electronics Corporation.



Disclaimer

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed.

All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.